# International **1628** Rectifier

#### Data Sheet No. PD60238 revE

# IRS2153(1)D(S)PbF

## SELF-OSCILLATING HALF-BRIDGE DRIVER IC

#### Features

- Integrated 600 V half-bridge gate driver
- C<sub>T</sub>, R<sub>T</sub> programmable oscillator
- 15.4 V Zener clamp on V<sub>CC</sub>
- Micropower startup
- Non-latched shutdown on C<sub>T</sub> pin (1/6th V<sub>CC</sub>)
- Internal bootstrap FET
- Excellent latch immunity on all inputs and outputs
- +/- 50 V/ns dV/dt immunity
- ESD protection on all pins
- 8-lead SOIC or PDIP package
- Internal deadtime

### Description

The IRS2153(1)D is based on the popular IR2153 selfoscillating half-bridge gate driver IC using a more advanced silicon platform, and incorporates a high voltage half-bridge gate driver with a front end oscillator similar to the industry standard CMOS 555 timer. HVIC and latch immune CMOS technologies enable rugged monolithic construction. The output driver features a high pulse current buffer stage designed for minimum driver cross-conduction. Noise immunity is achieved with low di/dt peak of the gate drivers.

#### **Product Summary**

Duty	cycle	

VOFFSET

Driver source/sink current

Vclamp

Deadtime

50% 180 mA/260 mA typ.

600 V Max

15.4 V typ.

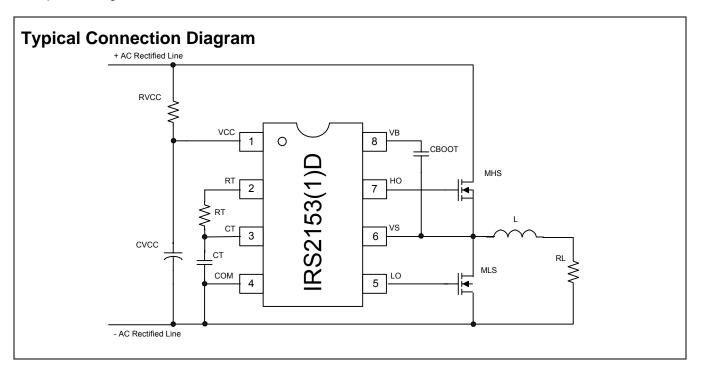
1.1 μs typ. (IRS2153D) 0.6 μs typ. (IRS21531D)

#### Package





SO8 IRS2153(1)DSPbF



### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

	Parameter			
Symbol	Definition	Min.	Max.	Units
VB	High side floating supply voltage	-0.3	625	
Vs	High side floating supply offset voltage	V <sub>B</sub> - 25	V <sub>B</sub> + 0.3	V
V <sub>HO</sub>	High side floating output voltage	V <sub>S</sub> – 0.3	V <sub>B</sub> + 0.3	v
$V_{\text{lo}}$	Low side output voltage	-0.3	V <sub>CC</sub> + 0.3	
I <sub>RT</sub>	R <sub>T</sub> pin current	-5	5	mA
V <sub>RT</sub>	R <sub>T</sub> pin voltage	-0.3	V <sub>CC</sub> + 0.3	
V <sub>CT</sub>	C <sub>T</sub> pin voltage	-0.3	V <sub>CC</sub> + 0.3	V
Icc	Supply current (Note 1)		20	
I <sub>OMAX</sub>	Maximum allowable current at LO and HO due to external power transistor Miller effect.	-500	500	mA
dV <sub>S</sub> /dt	Allowable offset voltage slew rate	-50	50	V/ns
PD	Maximum power dissipation @ $T_A \le +25 \text{ °C}$ , 8-Pin DIP		1.0	
PD	Maximum power dissipation @ $T_A \le +25 \text{ °C}$ , 8-Pin SOIC		0.625	W
R <sub>thJA</sub>	Thermal resistance, junction to ambient, 8-Pin DIP		85	
R <sub>thJA</sub>	Thermal resistance, junction to ambient, 8-Pin SOIC		128	°C/W
TJ	Junction temperature	-55	150	
Ts	Storage temperature	-55	150	°C
TL	Lead temperature (soldering, 10 seconds)		300	1

**Note 1:** This IC contains a zener clamp structure between the chip  $V_{CC}$  and COM which has a nominal breakdown voltage of 15.4 V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the  $V_{CLAMP}$  specified in the Electrical Characteristics section.

## International **IOR** Rectifier

# IRS2153(1)D

### **Recommended Operating Conditions**

For proper operation the device should be used within the recommended conditions.

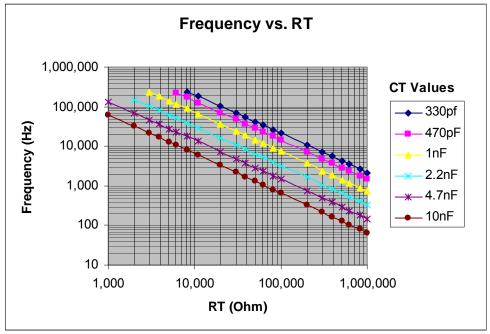
	Parameter			
Symbol	Definition	Min.	Max.	Units
V <sub>BS</sub>	High side floating supply voltage	V <sub>CC</sub> - 0.7	VCLAMP	
Vs	Steady state side floating supply offset voltage	-3.0 (Note 2)	600	V
Vcc	Supply voltage	V <sub>CCUV+</sub> +0.1 V	V <sub>CC CLAMP</sub>	
Icc	Supply current	(Note 3)	5	mA
TJ	Junction temperature	-40	125	°C

- Note 2: It is recommended to avoid output switching conditions where the negative-going spikes at the  $V_S$  node would decrease  $V_S$  below ground by more than -5 V.
- **Note 3:** Enough current should be supplied to the V<sub>CC</sub> pin of the IC to keep the internal 15.6 V zener diode clamping the voltage at this pin.

### **Recommended Component Values**

Parameter				
Symbol	Component	Min.	Max.	Units
R⊤	Timing resistor value	1		kΩ
Ст	$C_T$ pin capacitor value	330		pF

 $V_{BIAS}$  (V<sub>CC</sub>, V<sub>BS</sub>) = 14 V, V<sub>S</sub>=0 V and T<sub>A</sub> = 25 °C, CLO = CHO = 1 nF.



For further information, see Fig. 12.

# International **ICR** Rectifier

## **Electrical Characteristics**

 $V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 14 V,  $C_T$  = 1 nF,  $V_S$ =0 V and  $T_A$  = 25 °C unless otherwise specified. The output voltage and current ( $V_o$  and  $I_o$ ) parameters are referenced to COM and are applicable to the respective output leads: HO or LO. CLO = CHO = 1 nF.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions
Low Volt	age Supply Characteristics	•				
V <sub>CCUV</sub> +	Rising V <sub>CC</sub> undervoltage lockout threshold	10.0	11.0	12.0		
V <sub>CCUV</sub> -	Falling V <sub>CC</sub> undervoltage lockout threshold	8.0	9.0	10.0	V	
VCCUVHYS	V <sub>CC</sub> undervoltage lockout hysteresis	1.6	2.0	2.4		
Ιοςςυν	Micropower startup V <sub>CC</sub> supply current		130	170		$V_{CC} \leq V_{CCUV}$
lqcc	Quiescent V <sub>CC</sub> supply current		800	1000	μA	
lcc	V <sub>CC</sub> supply current		1.8		mA	R <sub>T</sub> = 36.9 kΩ
V <sub>CC CLAMP</sub>	V <sub>CC</sub> zener clamp voltage	14.4	15.4	16.8	V	I <sub>CC</sub> = 5 mA
Floating	Supply Characteristics					
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> supply current		60	80	μA	
V <sub>BSUV+</sub>	V <sub>BS</sub> supply undervoltage positive going threshold	8.0	9.0	9.5	V	
V <sub>BSUV-</sub>	V <sub>BS</sub> supply undervoltage negative going threshold	7.0	8.0	9.0	V	
I <sub>LK</sub>	Offset supply leakage current			50	μA	$V_{\rm B} = V_{\rm S} = 600 \ V$
Oscillato	r I/O Characteristics					
£		18.4	19.0	19.6	kHz	R <sub>T</sub> = 36.5 kΩ
f <sub>OSC</sub>	Oscillator frequency	88	93	100	KIIZ	R <sub>T</sub> = 7.15 kΩ
d	$R_T$ pin duty cycle		50		%	f <sub>o</sub> < 100 kHz
Ict	$C_T$ pin current		0.02	1.0	μA	
ICTUV	UV-mode $C_T$ pin pulldown current	0.20	0.30	0.6	mA	$V_{CC}$ = 7 V
V <sub>CT+</sub>	Upper $C_T$ ramp voltage threshold		9.32			
V <sub>CT</sub> -	Lower $C_T$ ramp voltage threshold		4.66		V	
VCTSD	$C_T$ voltage shutdown threshold	2.2	2.3	2.4		
V <sub>RT+</sub>	High-level $R_T$ output voltage, $V_{CC}$ - $V_{RT}$		10	50		I <sub>RT</sub> = -100 μA
VRI+			100	300		I <sub>RT</sub> = -1 mA
V <sub>RT-</sub>	Low-level R⊤ output voltage		10	50		I <sub>RT</sub> = 100 μA
vKI-			100	300		I <sub>RT</sub> <b>= 1 mA</b>
VRTUV	UV-mode $R_T$ output voltage		0	100		$V_{CC} \leq V_{CCUV}$
V <sub>RTSD</sub>	SD-mode $R_T$ output voltage, V <sub>CC</sub> - V <sub>RT</sub>		10	50	mV	I <sub>RT</sub> = -100 μA, V <sub>CT</sub> = 0 V
			100	300		l <sub>RT</sub> = -1 mA, V <sub>CT</sub> = 0 V

# International **tor** Rectifier

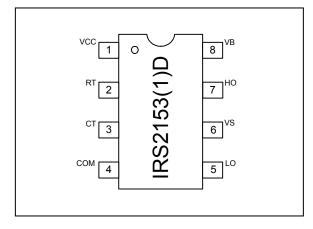
### **Electrical Characteristics**

 $V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 14 V,  $C_T$  = 1 nF,  $V_S$ =0 V and  $T_A$  = 25 °C unless otherwise specified. The output voltage and current ( $V_o$  and  $I_o$ ) parameters are referenced to COM and are applicable to the respective output leads: HO or LO. CLO = CHO = 1 nF.

Symbol	Definition	Min	Тур	Max	Units	<b>Test Conditions</b>		
Gate Driv	Gate Driver Output Characteristics							
V <sub>OH</sub>	High-level output voltage		V <sub>CC</sub>					
Vol	Low-level output voltage		COM		V	l <sub>0</sub> = 0 A		
V <sub>OL_UV</sub>	UV-mode output voltage		СОМ			$\label{eq:loss_loss} \begin{split} I_O &= 0 \ A, \\ V_{CC} &\leq V_{CCUV}. \end{split}$		
tr	Output rise time		120	220				
t <sub>f</sub>	Output fall time		50	80	ns			
t <sub>sd</sub>	Shutdown propagation delay		350					
t <sub>d</sub>	Output deadtime (HO or LO) (IRS2153D)	0.65	1.1	1.75	μS			
t <sub>d</sub>	Output deadtime (HO or LO) (IRS21531D)	0.35	0.6	0.85	μS			
I <sub>O+</sub>	Output source current		180		mA			
I <sub>O-</sub>	Output sink current		260		ША			
Bootstrap FET Characteristics								
$V_{B_{ON}}$	$V_{\text{B}}$ when the bootstrap FET is on		13.7		V			
I <sub>B_CAP</sub>	$V_{\text{B}}$ source current when FET is on	40	55		mA	C <sub>BS</sub> =0.1 uF		
I <sub>B_10V</sub>	$V_{\text{B}}$ source current when FET is on	10	12			V <sub>B</sub> =10 V		

# International **tor** Rectifier

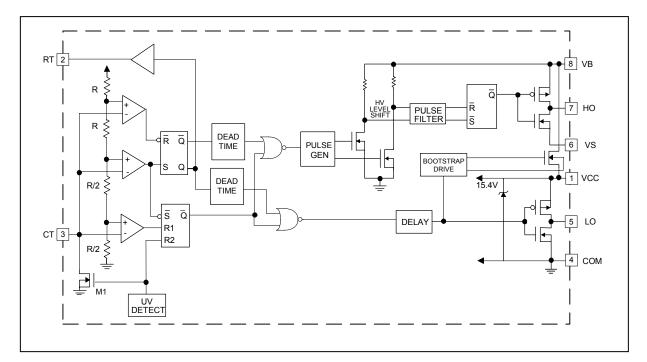
## Lead Definitions



	Lead			
Symbol	Description			
V <sub>CC</sub>	Logic and internal gate drive supply voltage			
RT	Oscillator timing resistor input			
Ст	Oscillator timing capacitor input			
COM	IC power and signal ground			
LO	Low-side gate driver output			
Vs	High voltage floating supply return			
HO	High-side gate driver output			
VB	High side gate driver floating supply			



## **Functional Block Diagram**

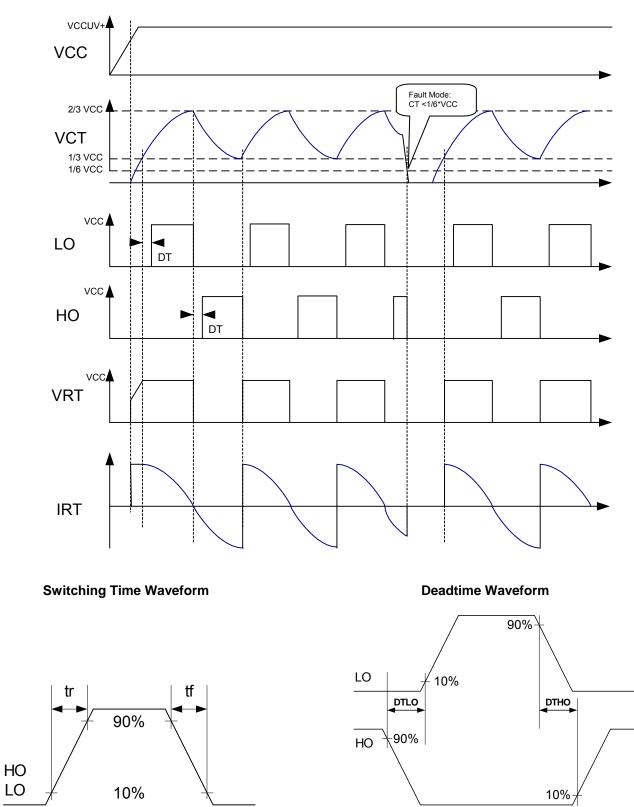


# International **ICR** Rectifier

# IRS2153(1)D

## **Timing Diagram**

#### **Operating Mode**



## International **TOR** Rectifier

## IRS2153(1)D

#### **Functional Description**

#### Under-voltage Lock-Out Mode (UVLO)

The under-voltage lockout mode (UVLO) is defined as the state the IC is in when V<sub>CC</sub> is below the turn-on threshold of the IC. The IRS2153(1)D under voltage lock-out is designed to maintain an ultra low supply current of less than 170  $\mu$ A, and to guarantee the IC is fully functional before the high and low side output drivers are activated. During under voltage lock-out mode, the high and low-side driver outputs HO and LO are both low.

#### Supply voltage

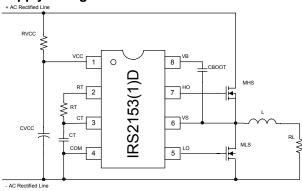


Fig. 1 Typical Connection Diagram

Fig. 1 shows an example of supply voltage. The start-up capacitor ( $C_{VCC}$ ) is charged by current through supply resistor ( $R_{VCC}$ ) minus the start-up current drawn by the IC. This resistor is chosen to provide sufficient current to supply the IRS2153(1)D from the DC bus.  $C_{VCC}$  should be large enough to hold the voltage at Vcc above the UVLO threshold for one half cycle of the line voltage as it will only be charged at the peak, typically 0.1 uF. It will be necessary for  $R_{VCC}$  to dissipate around 1 W.

The use of a two diode charge pump made of DC1, DC2 and CVS (Fig. 2) from the half bridge (V<sub>S</sub>) is also possible however the above approach is simplest and the dissipation in  $R_{VCC}$  should not be unacceptably high.

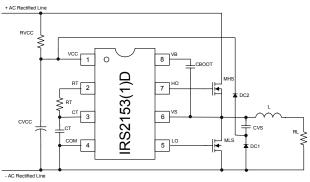


Fig. 2 Charge pump circuit

The supply resistor ( $R_{VCC}$ ) must be selected such that enough supply current is available over all operating conditions.

Once the capacitor voltage on  $V_{CC}$  reaches the start-up threshold  $V_{CCUV+}$ , the IC turns on and HO and LO begin to oscillate.

#### **Bootstrap MOSFET**

The internal bootstrap FET and supply capacitor ( $C_{BOOT}$ ) comprise the supply voltage for the high side driver circuitry. The internal boostrap FET only turns on when LO is high. To guarantee that the high-side supply is charged up before the first pulse on pin HO, the first pulse from the output drivers comes from the LO pin.

#### Normal operating mode

Once the V<sub>CCUV+</sub> threshold is passed, the MOSFET M1 opens, RT increases to approximately V<sub>CC</sub> (V<sub>CC</sub>-V<sub>RT+</sub>) and the external CT capacitor starts charging. Once the CT voltage reaches V<sub>CT</sub>- (about 1/3 of V<sub>CC</sub>), established by an internal resistor ladder, LO turns on with a delay equivalent to the deadtime (t<sub>d</sub>). Once the CT voltage reaches V<sub>CT+</sub> (approximately 2/3 of V<sub>CC</sub>), LO goes low, RT goes down to approximately ground (V<sub>RT-</sub>), the CT capacitor discharges and the deadtime circuit is activated. At the end of the deadtime, HO goes high again, the deadtime is activated. At the end of the deadtime, LO goes high and the cycle starts over again.

The following equation provides the oscillator frequency:

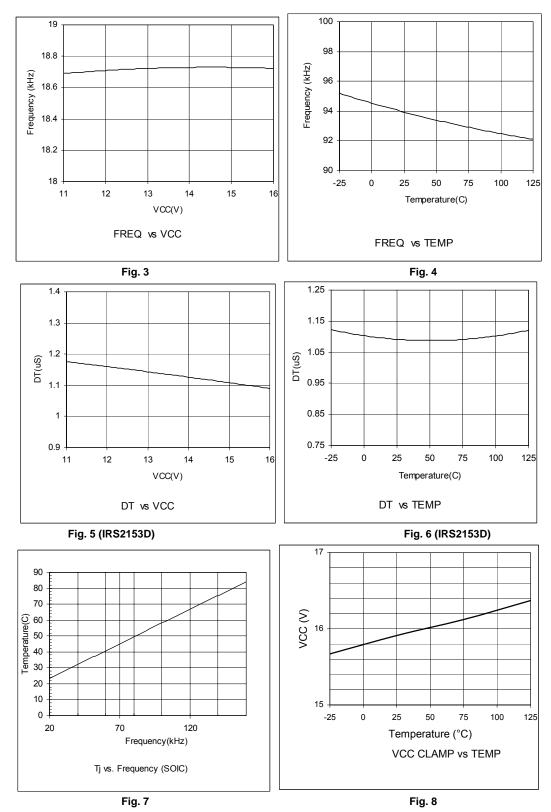
$$f \sim \frac{1}{1.453 \times RT \times CT}$$

This equation can vary slightly from actual measurements due to internal comparator over- and under-shoot delays. For a more accurate determination of the output frequency, the frequency characteristic curves should be used (RT vs. Frequency, page 3).

#### Shut-down

If CT is pulled down below V<sub>CTSD</sub> (approximately 1/6 of V<sub>cc</sub>) by an external circuit, CT doesn't charge up and oscillation stops. LO is held low and the bootstrap FET is off. Oscillation will resume once CT is able to charge up again to V<sub>CT</sub>.

## International **TOR** Rectifier



# International **tor** Rectifier

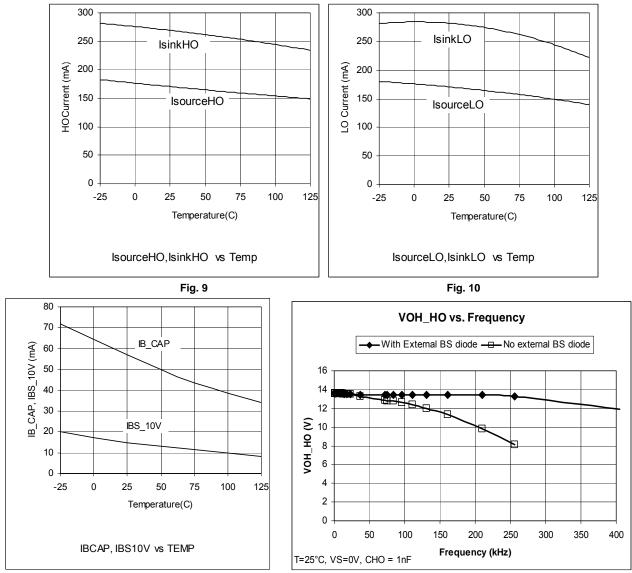




Fig. 12

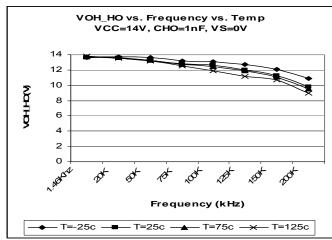
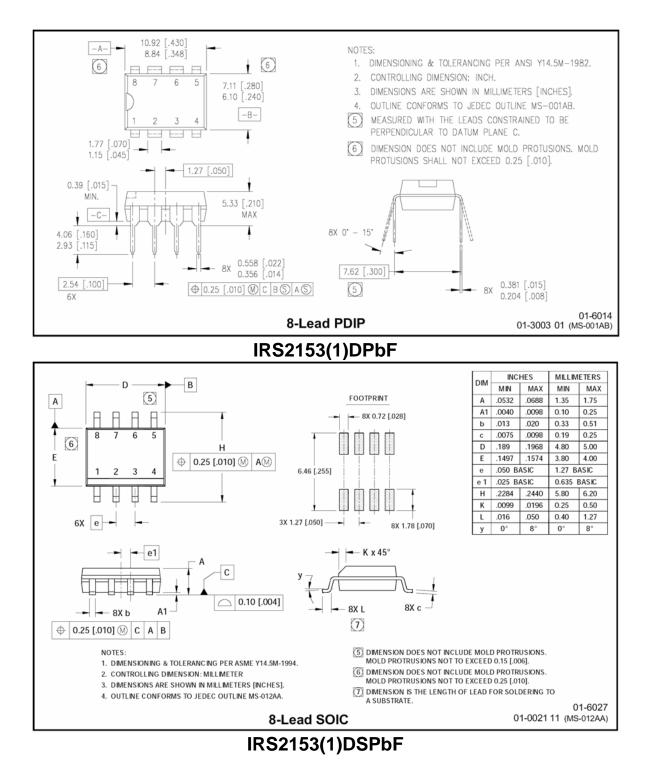


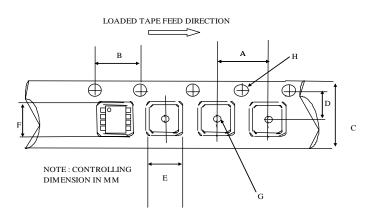
Fig. 13

# International **ICR** Rectifier

## IRS2153(1)D

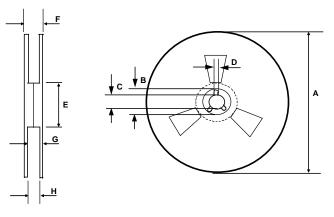


## International **ICR** Rectifier



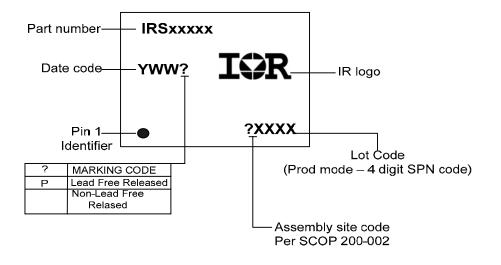
#### CARRIER TAPE DIMENSION FOR 8SOICN

	Metric		Imperial		
Code	Min	Max	Min	Max	
А	7.90	8.10	0.311	0.318	
В	3.90	4.10	0.153	0.161	
С	11.70	12.30	0.46	0.484	
D	5.45	5.55	0.214	0.218	
E	6.30	6.50	0.248	0.255	
F	5.10	5.30	0.200	0.208	
G	1.50	n/a	0.059	n/a	
Н	1.50	1.60	0.059	0.062	



#### REEL DIMENSIONS FOR 8SOICN

	Me	etric	Imperial		
Code	Min	Max	Min	Max	
A	329.60	330.25	12.976	13.001	
В	20.95	21.45	0.824	0.844	
С	12.80	13.20	0.503	0.519	
D	1.95	2.45	0.767	0.096	
E	98.00	102.00	3.858	4.015	
F	n/a	18.40	n/a	0.724	
G	14.50	17.10	0.570	0.673	
Н	12.40	14.40	0.488	0.566	



### PART MARKING INFORMATION

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8-Lead PDIP IRS2153DPbF 8-Lead PDIP IRS21531DPbF 8-Lead SOIC IRS2153DSPbF 8-Lead SOIC IRS21531DSPbF 8-Lead SOIC Tape & Reel IRS2153DSTRPbF 8-Lead SOIC Tape & Reel IRS21531DSTRPbF

International

The SOIC-8 is MSL2 qualified. This product has been designed and qualified for the industrial level. Qualification standards can be found at <u>www.irf.com</u> <a href="http://www.irf.com">www.irf.com</a> IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 252-7105 Data and specifications subject to change without notice. 6/27/2006

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